

STGW35NC120HD

35 A - 1200 V - very fast IGBT

Features

- Low on-losses
- Low on-voltage drop (V_{CE(sat)})
- High current capability
- High input impedance (voltage driven)
- Low gate charge
- Ideal for soft switching application

Application

■ Induction heating

Description

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

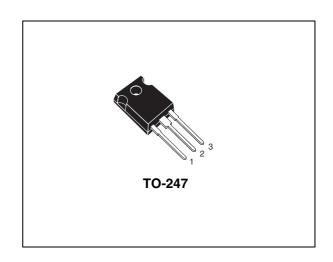


Figure 1. Internal schematic diagram

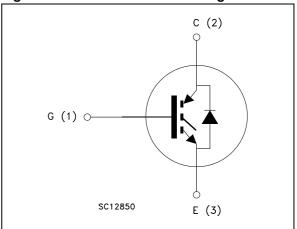


Table 1. Device summary

| Order code | Marking | Package | Packaging | |
|---------------|-------------|---------|-----------|--|
| STGW35NC120HD | GW35NC120HD | TO-247 | Tube | |

Contents STGW35NC120HD

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STGW35NC120HD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------------------|--|------------|------|
| V _{CES} | Collector-emitter voltage (V _{GE} = 0) | 1200 | V |
| I _C ⁽¹⁾ | Collector current (continuous) at 25 °C | 58 | Α |
| I _C ⁽¹⁾ | Collector current (continuous) at 100 °C | 34 | Α |
| I _{CL} ⁽²⁾ | Turn-off latching current | 135 | Α |
| I _{CP} ⁽³⁾ | Pulsed collector current | 135 | Α |
| V _{GE} | Gate-emitter voltage | ±25 | V |
| P _{TOT} | Total dissipation at T _C = 25 °C | 220 | W |
| IF | Diode RMS forward current at T _C = 25 °C | 30 | Α |
| I _{FSM} | Surge non repetitive forward current t _p = 10 ms sinusoidal | 100 | А |
| T _j | Operating junction temperature | -55 to 150 | °C |
| T _{stg} | Storage temperature | -33 10 130 | |

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T_{C}, \ I_{C})}}$$

- 2. Vclamp = 80% of V_{CES} , T_j =150 °C, R_G =10 Ω , V_{GE} =15 V
- 3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal resistance

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|-----------------------|--|------|------|-------|------|
| R | Thermal resistance junction-case IGBT | | | 0.562 | °C/W |
| R _{thj-case} | Thermal resistance junction-case diode | | | 1.5 | °C/W |
| R _{thj-amb} | Thermal resistance junction-ambient | | | 50 | °C/W |

Electrical characteristics STGW35NC120HD

2 Electrical characteristics

(T_{CASE} =25°C unless otherwise specified)

Table 4. Static

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|----------------------|---|---|------|------------|-----------|----------|
| V _{BR(CES)} | Collector-emitter breakdown voltage (V _{GE} = 0) | I _C = 1 mA | 1200 | | | V |
| V _{CE(SAT)} | Collector-emitter saturation voltage | V _{GE} = 15 V, I _C = 20 A, V _{GE} = 15 V, I _C = 20 A, T _C =125 °C | | 2.2 2.0 | 2.75 | V V |
| V _{GE(th)} | Gate threshold voltage | $V_{CE} = V_{GE}$, $I_{C} = 250 \mu A$ | 3.75 | | 5.75 | V |
| I _{CES} | Collector-emitter leakage current (V _{GE} = 0) | V _{CE} =1200 V V _{CE} =1200 V, T _C =125 °C | | | 500 10 | μA mA |
| I _{GES} | Gate-emitter leakage current (V _{CE} = 0) | V _{GE} =± 20 V | | | ± 100 | nA |
| 9 _{fs} (1) | Forward transconductance | V _{CE} = 25 V _, I _C = 20 A | | 14 | | S |

^{1.} Pulse duration = 300 μ s, duty cycle 1.5%

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|---|---|------|-------------------|------|----------------|
| C _{ies} C _{oes} C _{res} | Input capacitance Output capacitance Reverse transfer capacitance | V _{CE} = 25 V, f = 1 MHz, V _{GE} =0 | | 2510 175 30 | | pF pF pF |
| Q _g Q _{ge} Q _{gc} | Total gate charge Gate-emitter charge Gate-collector charge | V _{CE} = 960 V, I _C = 20 A,V _{GE} =15 V | | 110 16 49 | 120 | nC nC nC |

Table 6. Switching on/off (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|---|---|------|-------------------|------|------------------|
| t _{d(on)} t _r (di/dt) _{on} | Turn-on delay time Current rise time Turn-on current slope | V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω V _{GE} = 15 V, (see Figure 17) | | 29 11 1820 | | ns ns A/µs |
| t _{d(on)} t _r (di/dt) _{on} | Turn-on delay time Current rise time Turn-on current slope | $V_{CC} = 960 \text{ V, } I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega \text{ V}_{GE} = 15 \text{ V,}$ $T_{C} = 125 \text{ °C}$ (see Figure 17) | | 27 14 1580 | | ns ns A/µs |
| $t_{\rm r}({\rm V}_{\rm off}) \\ t_{\rm d}(_{\rm off}) \\ t_{\rm f}$ | Off voltage rise time Turn-off delay time Current fall time | V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω V_{GE} = 15 V, (see Figure 17) | | 90 275 312 | | ns ns ns |
| $t_{\rm r}({\rm V}_{\rm off}) \\ t_{\rm d}(_{\rm off}) \\ t_{\rm f}$ | Off voltage rise time Turn-off delay time Current fall time | V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω V _{GE} = 15 V, T_{C} = 125 °C (see Figure 17) | | 150 336 592 | | ns ns ns |

Table 7. Switching energy (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|---|--|------|----------------------|------|----------------|
| Eon ⁽¹⁾ E_{off} E_{ts} | Turn-on switching losses Turn-off switching losses Total switching losses | V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω V _{GE} = 15 V, (see Figure 17) | | 1660 4438 6098 | | μJ μJ μJ |
| Eon ⁽¹⁾ E _{off} ⁽²⁾ E _{ts} | Turn-on switching losses Turn-off switching losses Total switching losses | $V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega V_{GE} = 15 \text{ V},$ $T_{C} = 125 \text{ °C} \text{ (see Figure 17)}$ | | 3015 6900 9915 | | μJ μJ μJ |

Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

Table 8. Collector-emitter diode

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|------------------|--------------------------|---|------|------|------|------|
| V _F | Forward on-voltage | I _F = 20 A | | 1.9 | 2.5 | V |
| V F | Polward on-voltage | $I_F = 20 \text{ A}, T_C = 125 \text{ °C}$ | | 1.7 | | V |
| t _{rr} | Reverse recovery time | $I_F = 20 \text{ A}, V_R = 27 \text{ V},$ | | 152 | | ns |
| Q_{rr} | Reverse recovery charge | $T_C = 125 ^{\circ}C$, di/dt = 100 A/ μ s | | 722 | | nC |
| I _{rrm} | Reverse recovery current | (see Figure 20) | | 9 | | Α |

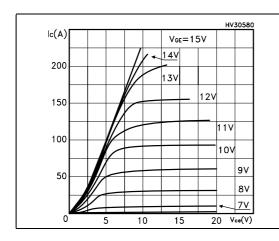
^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGW35NC120HD

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



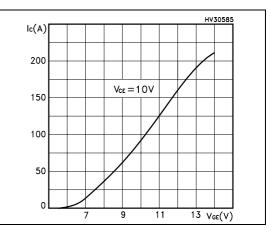
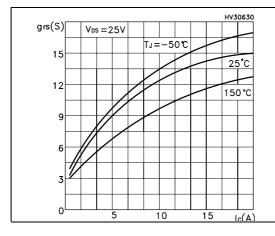


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs. temperature



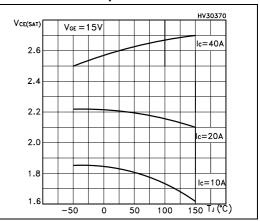
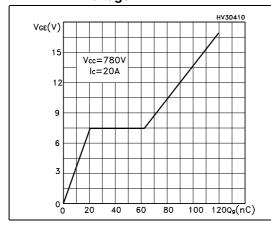


Figure 6. Gate charge vs. gate-source voltage

Figure 7. Capacitance variations



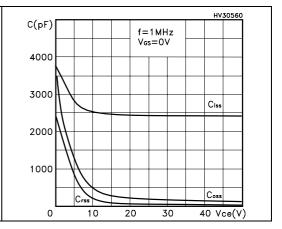


Figure 8. Normalized gate threshold voltage vs. temperature

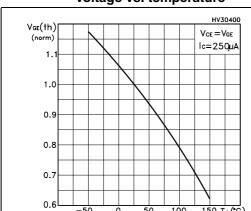


Figure 9. Collector-emitter on voltage vs. collector current

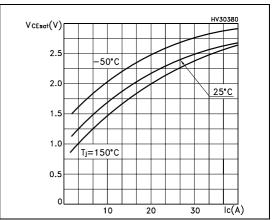


Figure 10. Normalized breakdown voltage vs. temperature

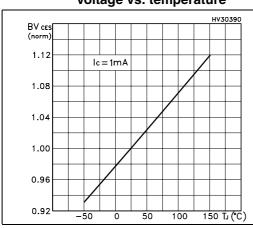


Figure 11. Switching losses vs. temperature

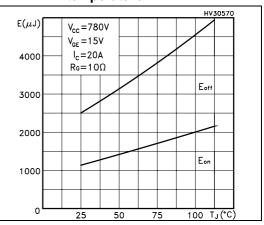


Figure 12. Switching losses vs. gate resistance

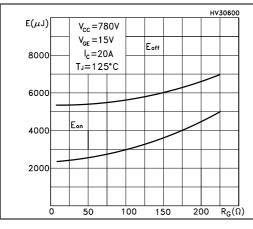
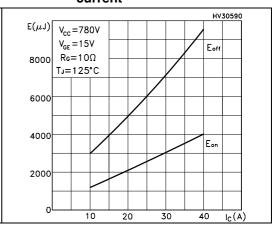


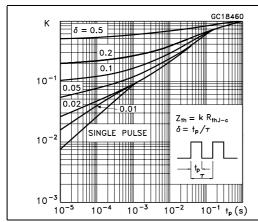
Figure 13. Switching losses vs. collector current



Electrical characteristics STGW35NC120HD

Figure 14. Thermal Impedance

Figure 15. Turn-off SOA



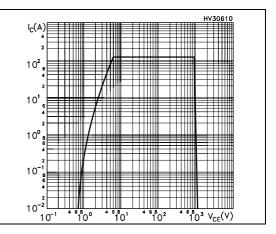
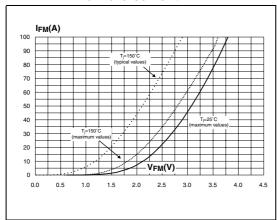


Figure 16. Forward voltage drop vs. forward current



STGW35NC120HD Test circuit

3 Test circuit

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

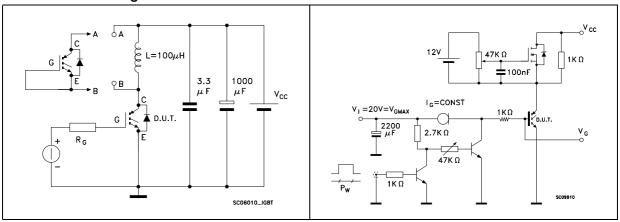
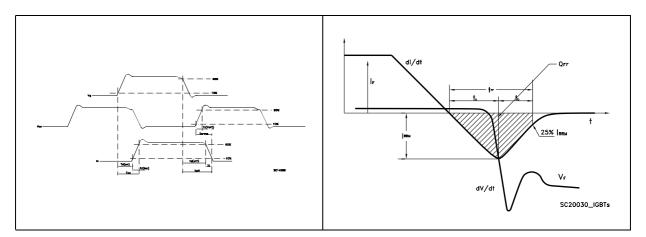


Figure 19. Switching waveform

Figure 20. Diode recovery time waveform

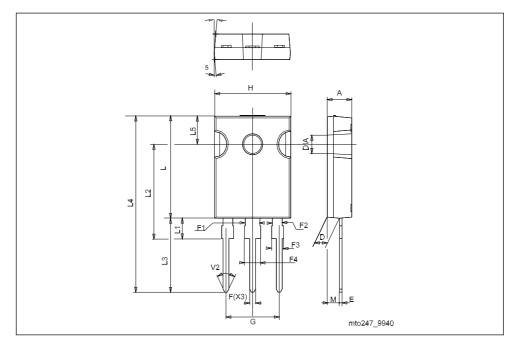


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-247 MECHANICAL DATA

| DIM. | | mm. | | | inch | |
|--------|-------|-------|-------|-------|-------|-------|
| DIIVI. | MIN. | TYP | MAX. | MIN. | TYP. | MAX. |
| Α | 4.90 | | 5.16 | 0.193 | | 0.203 |
| D | 2.35 | | 2.45 | 0.093 | | 0.096 |
| Е | 0.6 | | 0.76 | 0.024 | | 0.030 |
| F | 1.2 | | 1.33 | 0.047 | | 0.052 |
| F1 | | 3 | | | 0.118 | |
| F2 | | 2 | | | 0.078 | |
| F3 | 1.9 | | 2.13 | 0.075 | | 0.084 |
| F4 | 3.04 | | 3.2 | 0.120 | | 0.126 |
| G | | 10.90 | | | 0.429 | |
| Н | 15.77 | | 16.03 | 0.621 | | 0.631 |
| L | 20.83 | | 21.09 | 0.820 | | 0.830 |
| L1 | 3.93 | | 4.45 | 0.155 | | 0.175 |
| L2 | 18.72 | | 19.18 | 0.737 | | 0.755 |
| L3 | 20.04 | | 20.31 | 0.789 | | 0.800 |
| L4 | 40.88 | | 41.40 | 1.609 | | 1.630 |
| L5 | 6.04 | | 6.30 | 0.238 | | 0.248 |
| М | 2 | | 3 | | 0.078 | 0.118 |
| V | | 5° | | | 5° | |
| V2 | | 60° | | | 60° | |
| Diam | 3.56 | | 3.66 | 0.140 | | 0.144 |



Revision history STGW35NC120HD

5 Revision history

Table 9. Document revision history

| Date | Revision | Changes |
|-------------|----------|--------------|
| 25-Jan-2008 | 1 | First issue. |

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